IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for half bridge resonant applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

Features

- Low Saturation Voltage using Trench with Fieldstop Technology
- Low Switching Loss Reduces System Power Dissipation
- Low Gate Charge
- Soft, Fast Free Wheeling Diode
- These are Pb–Free Devices

Typical Applications

- Inverter Welding
- UPS Systems

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	600	V
Collector current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	Ι _C	60 30	A
Pulsed collector current, T_{pulse} limited by T_{Jmax}	I _{CM}	120	A
Diode forward current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	I _F	60 30	A
Diode pulsed current, T_{pulse} limited by T_{Jmax}	I _{FM}	120	A
Gate-emitter voltage	V _{GE}	±20	V
Power Dissipation @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	P _D	189 76	W
Operating junction temperature range	TJ	–55 to +150	°C
Storage temperature range	T _{stg}	-55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

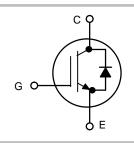
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

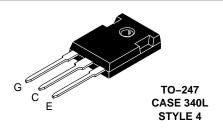


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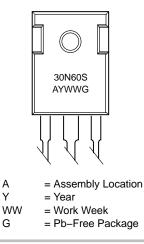
http://onsemi.com

30 A, 600 V V_{CEsat} = 1.9 V E_{off} = 0.54 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB30N60SWG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

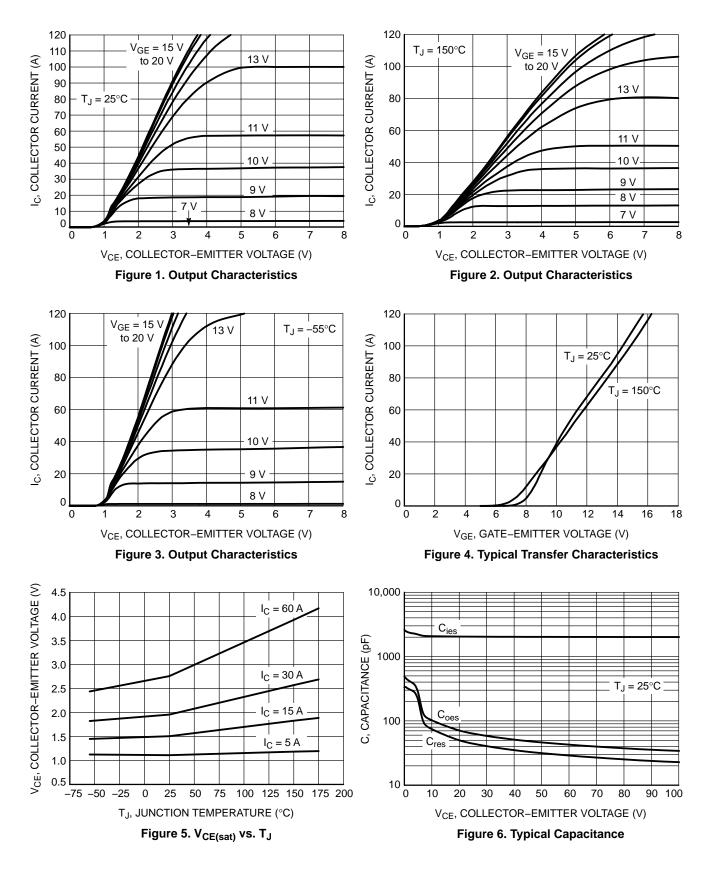
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.66	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	2.73	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

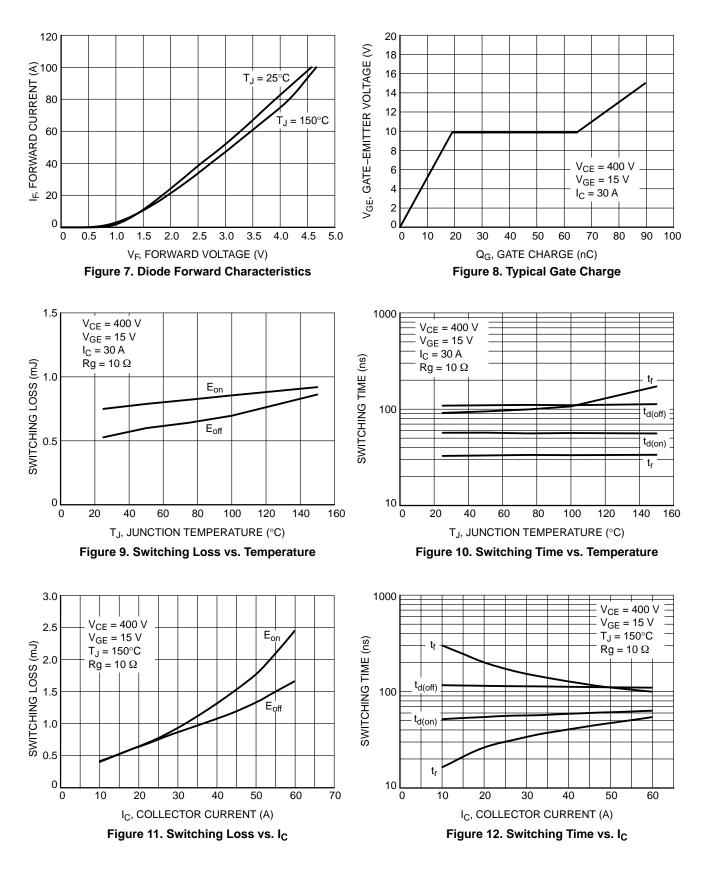
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

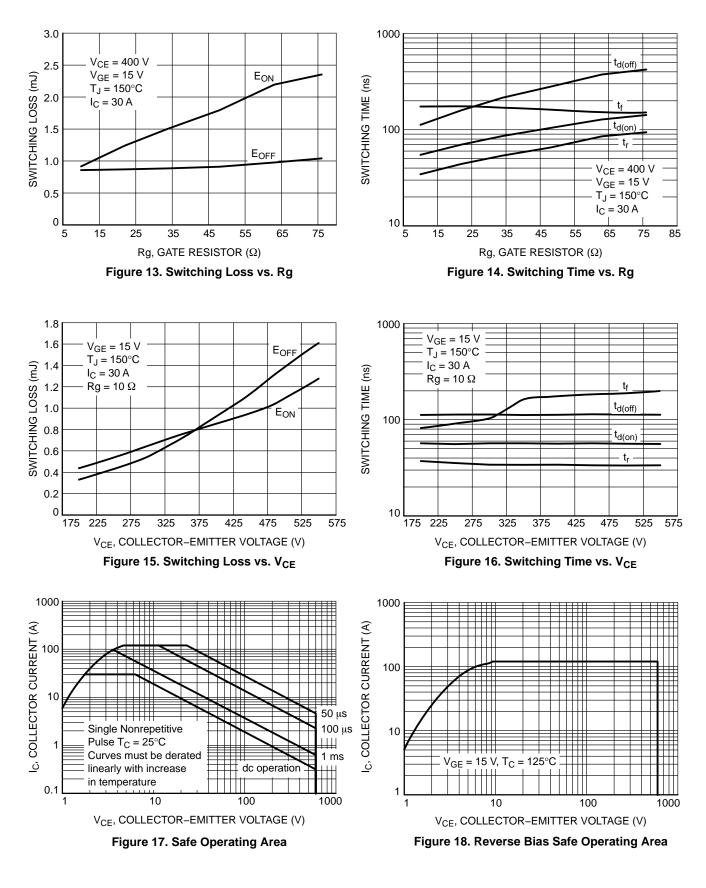
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•					
Collector–emitter breakdown voltage, gate–emitter short–circuited	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 500 \mu\text{A}$	V _{(BR)CES}	600	_	-	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 30 A V_{GE} = 15 V, I _C = 30 A, T _J = 150°C	V _{CEsat}	-	1.9 2.6	2.2	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 150 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 600 V$ $V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 150^{\circ}C$	I _{CES}	-		0.2 2	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$, $V_{CE} = 0 \text{ V}$	I _{GES}	-	_	100	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		C _{ies}	_	2040	-	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	70	-	
Reverse transfer capacitance		C _{res}	-	50	-	
Gate charge total		Qg		90		nC
Gate to emitter charge	V_{CE} = 480 V, I _C = 30 A, V _{GE} = 15 V	Q _{ge}		19		
Gate to collector charge		Q _{gc}		45		
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn–on delay time		t _{d(on)}		57		ns
Rise time]	tr		32		
Turn–off delay time	$T_J = 25^{\circ}C$ $V_{CC} = 400 \text{ V}, \text{ I}_C = 30 \text{ A}$	t _{d(off)}		109		
Fall time	R _g = 10 Ω V _{GE} = 0 V/ 15 V	t _f		91		
Turn-on switching loss		E _{on}		0.75		mJ
Turn–off switching loss		E _{off}		0.54		mJ
Turn–on delay time		t _{d(on)}		56		ns
Rise time		tr		34		
Turn–off delay time	$T_{J} = 150^{\circ}C$ $V_{CC} = 400 \text{ V, } I_{C} = 30 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15 \text{ V}$	t _{d(off)}		113		
Fall time		t _f		172		
Turn-on switching loss		E _{on}		0.91		mJ
	-	E _{off}		T		

Forward voltage	V _{GE} = 0 V, I _F = 30 A V _{GE} = 0 V, I _F = 30 A, T _J = 150°C	V _F	2.3 2.5	2.5	V
Reverse recovery time	$T_J = 25^{\circ}C$	t _{rr}	200		ns
Reverse recovery charge	I _F = 30 A, V _R = 400 V di _F /dt = 200 A/μs	Q _{rr}	1000		nc
Reverse recovery current		I _{rrm}	9		А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.







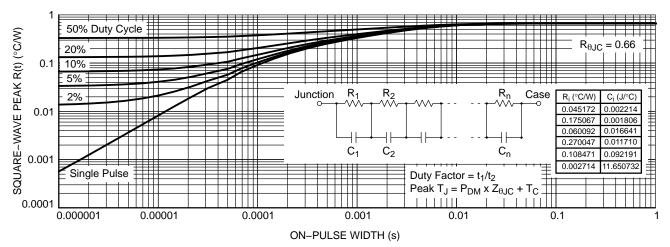


Figure 19. IGBT Die Self-heating Square-wave Duty Cycle Transient Thermal Response

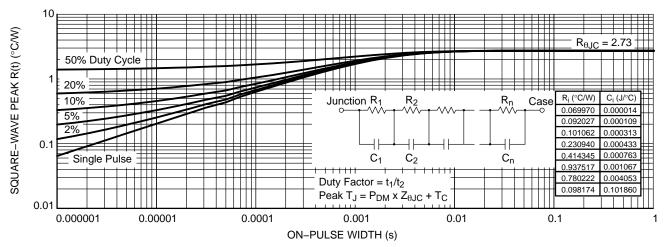


Figure 20. Diode Die Self-heating Square-wave Duty Cycle Transient Thermal Response

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

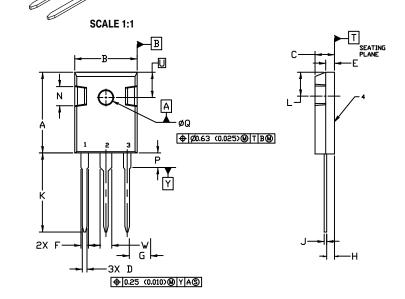
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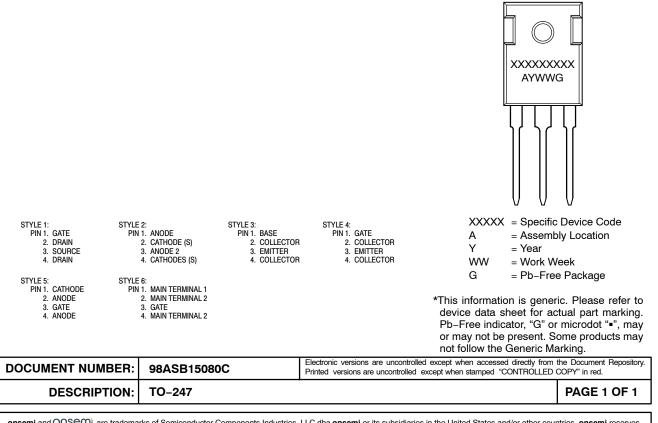


- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER



	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
Α	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
E	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45	BSC	0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
к	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15	BSC	0.242	BSC
V	2.87	3.12	0.113	0.123

GENERIC **MARKING DIAGRAM***



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